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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, LINbus, SIO, SSU, UART/USART
Peripherals	LCD, POR, PWM, Voltage Detect, WDT
Number of I/O	68
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 16x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2l388cnfa-v0

1.1.3 Specifications

Tables 1.4 to 1.6 list the Specifications.

Table 1.4 Specifications (1)

Item	Function		Specification
CPU	Central processing unit		R8C CPU core - Number of fundamental instructions: 89 - Minimum instruction execution time: 50 ns (f(XIN) = 20 MHz, VCC = 2.7 to 5.5 V) 200 ns (f(XIN) = 5 MHz, VCC = 1.8 to 5.5 V) - Multiplier: 16 bits × 16 bits → 32 bits - Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits - Operating mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM/RAM Data flash		Refer to Tables 1.7 to 1.10 Product Lists .
Power Supply Voltage Detection	Voltage detection circuit		- Power-on reset - Voltage detection 3 (detection level of voltage detection 0 and voltage detection 1 selectable)
I/O Ports	Programmable I/O ports	R8C/L35C Group	- CMOS I/O ports: 41, selectable pull-up resistor - High current drive ports: 5
		R8C/L36C Group	- CMOS I/O ports: 52, selectable pull-up resistor - High current drive ports: 8
		R8C/L38C Group	- CMOS I/O ports: 68, selectable pull-up resistor - High current drive ports: 8
		R8C/L3AC Group	- CMOS I/O ports: 88, selectable pull-up resistor - High current drive ports: 16
Clock	Clock generation circuits		4 circuits: XIN clock oscillation circuit XCIN clock oscillation circuit (32 kHz) High-speed on-chip oscillator (with frequency adjustment function) Low-speed on-chip oscillator - Oscillation stop detection: XIN clock oscillation stop detection function - Frequency divider circuit: Division ratio selectable from 1, 2, 4, 8, and 16 - Low-power-consumption modes: Standard operating mode (high-speed clock, low-speed clock, high-speed on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode, power-off mode
			Real-time clock (timer RE)
Interrupts		R8C/L35C Group	- Number of interrupt vectors: 69 - External Interrupt: 9 (INT × 5, key input × 4) - Priority levels: 7 levels
		R8C/L36C Group	- Number of interrupt vectors: 69 - External Interrupt: 12 (INT × 8, key input × 4) - Priority levels: 7 levels
		R8C/L38C Group	- Number of interrupt vectors: 69 - External Interrupt: 16 (INT × 8, key input × 8) - Priority levels: 7 levels
		R8C/L3AC Group	- Number of interrupt vectors: 69 - External Interrupt: 16 (INT × 8, key input × 8) - Priority levels: 7 levels
Watchdog Timer			14 bits × 1 (with prescaler) - Selectable reset start function - Selectable low-speed on-chip oscillator for watchdog timer
DTC (Data Transfer Controller)			1 channel - Activation sources: 38 - Transfer modes: 2 (normal mode, repeat mode)

Table 1.5 Specifications (2)

Item	Function	Specification	
Timer	Timer RA	8 bits × 1 (with 8-bit prescaler) Timer mode (period timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode	
	Timer RB	8 bits × 1 (with 8-bit prescaler) Timer mode (period timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode	
	Timer RC	16 bits × 1 (with 4 capture/compare registers) Timer mode (input capture function, output compare function), PWM mode (output: 3 pins), PWM2 mode (PWM output: 1 pin)	
	Timer RD	16 bits × 2 (with 4 capture/compare registers) Timer mode (input capture function, output compare function), PWM mode (output: 6 pins), reset synchronous PWM mode (three-phase waveform output: 6 pins, sawtooth wave modulation), complementary PWM mode (three-phase waveform output: 6 pins, triangular wave modulation), PWM3 mode (PWM output with fixed period: 2 pins)	
	Timer RE	8 bits × 1 Real-time clock mode (counting of seconds, minutes, hours, days of week), output compare mode	
	Timer RG	16 bits × 1 Phase-counting mode, timer mode (output compare function, input capture function), PWM mode (output: 1 pin)	
Serial Interface	UART0, UART1	Clock synchronous serial I/O/UART × 2 channels	
	UART2	Clock synchronous serial I/O/UART, I ² C mode (I ² C-bus), multiprocessor communication function	
Synchronous Serial Communication Unit (SSU)		1 (shared with I ² C-bus)	
I ² C bus		1 (shared with SSU)	
LIN Module		Hardware LIN: 1 channel (timer RA, UART0 used)	
A/D Converter	R8C/L35C Group	10-bit resolution × 10 channels, including sample and hold function, with sweep mode	
	R8C/L36C Group	10-bit resolution × 10 channels, including sample and hold function, with sweep mode	
	R8C/L38C Group	10-bit resolution × 16 channels, including sample and hold function, with sweep mode	
	R8C/L3AC Group	10-bit resolution × 20 channels, including sample and hold function, with sweep mode	
D/A Converter		8-bit resolution × 2 circuits	
Comparator B		2 circuits	
LCD Drive Control Circuit	R8C/L35C Group	Common output: Max. 4 pins Segment output: Max. 24 pins	Bias: 1/2, 1/3 Duty: static, 1/2, 1/3, 1/4
	R8C/L36C Group	Common output: Max. 8 pins Segment output: Max. 32 pins ⁽¹⁾	Bias: 1/2, 1/3, 1/4 Duty: static, 1/2, 1/3, 1/4, 1/8
	R8C/L38C Group	Common output: Max. 8 pins Segment output: Max. 48 pins ⁽¹⁾	
	R8C/L3AC Group	Common output: Max. 8 pins Segment output: Max. 56 pins ⁽¹⁾	
	Voltage multiplier and dedicated regulator integrated		

Note:

1. This applies when four pins are selected for common output.

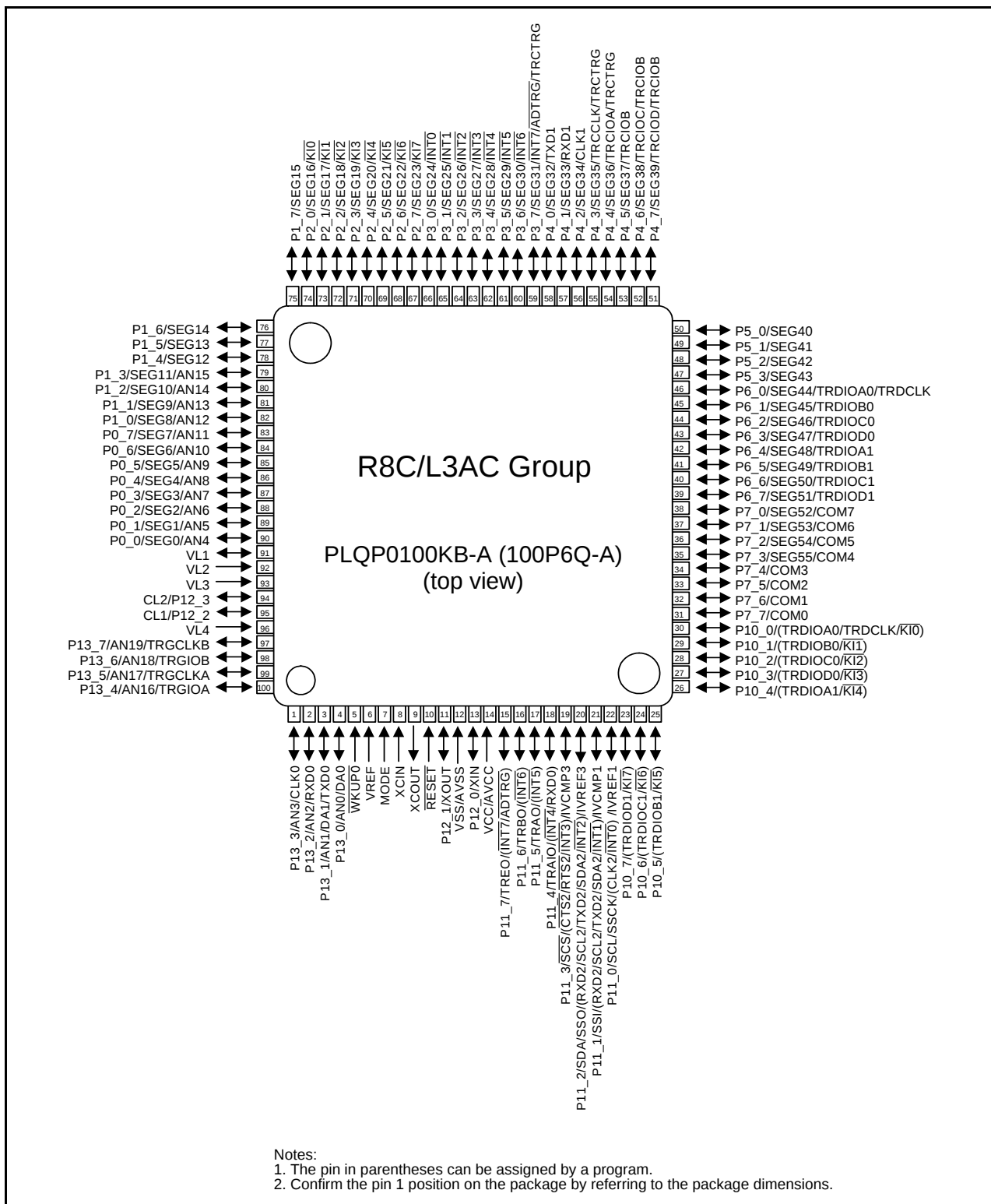


Figure 1.12 Pin Assignment (Top View) of PLQP0100KB-A Package

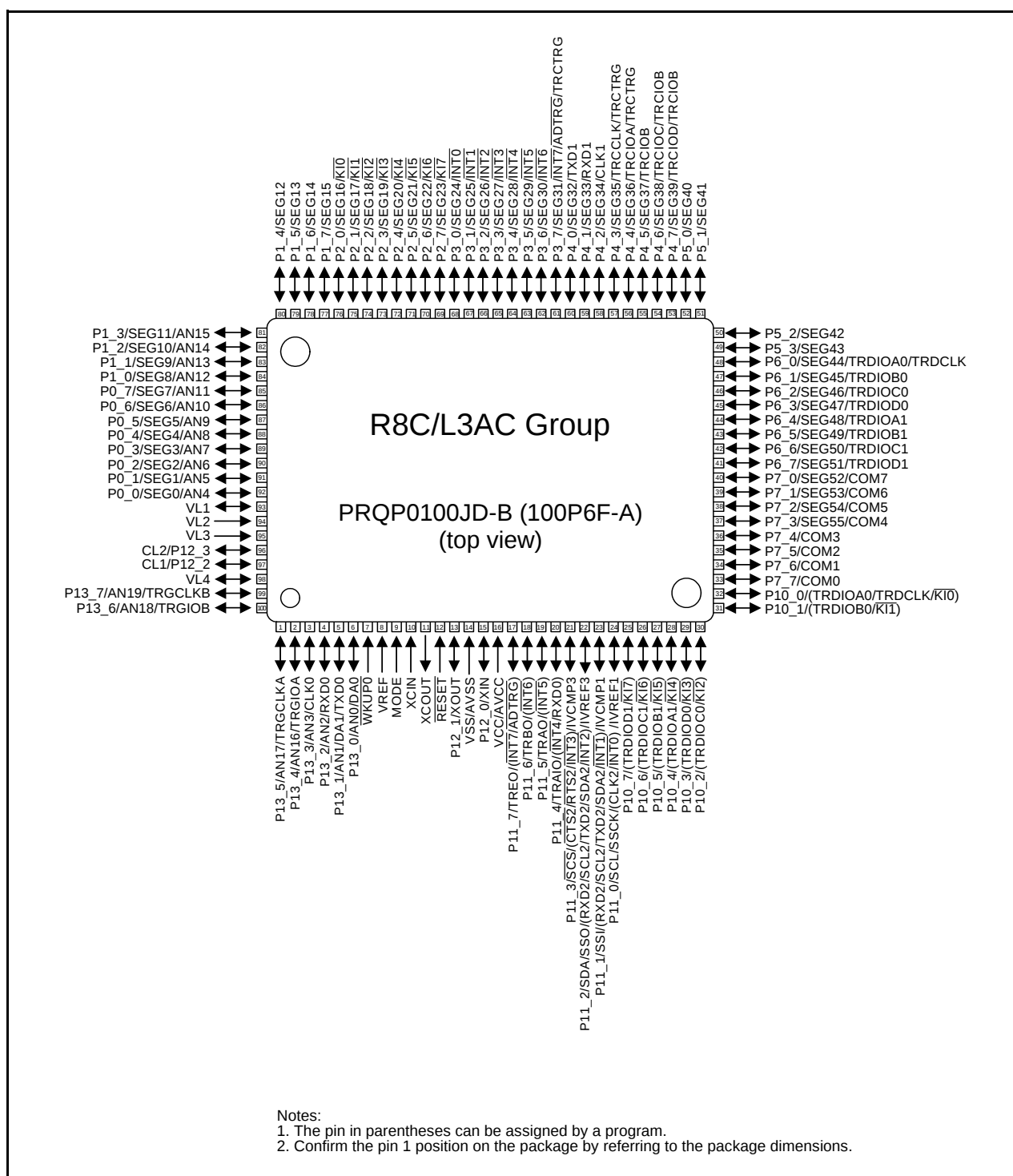


Figure 1.13 Pin Assignment (Top View) of PRQP0100JD-B Package

Table 4.2 SFR Information (2) (1)

Address	Register	Symbol	After Reset
003Ah	Voltage Monitor 2 Circuit Control Register	VW2C	10000010b
003Bh			
003Ch			
003Dh			
003Eh			
003Fh			
0040h			
0041h	Flash Memory Ready Interrupt Control Register	FMRDYIC	XXXXX000b
0042h			
0043h	INT7 Interrupt Control Register	INT7IC	XX00X000b
0044h	INT6 Interrupt Control Register	INT6IC	XX00X000b
0045h	INT5 Interrupt Control Register	INT5IC	XX00X000b
0046h	INT4 Interrupt Control Register	INT4IC	XX00X000b
0047h	Timer RC Interrupt Control Register	TRCIC	XXXXX000b
0048h	Timer RD0 Interrupt Control Register	TRD0IC	XXXXX000b
0049h	Timer RD1 Interrupt Control Register	TRD1IC	XXXXX000b
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh	UART2 Transmit Interrupt Control Register	S2TIC	XXXXX000b
004Ch	UART2 Receive Interrupt Control Register	S2RIC	XXXXX000b
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	SSU Interrupt Control Register / IIC bus Interrupt Control Register (2)	SSUIC/IICIC	XXXXX000b
0050h			
0051h	UART0 Transmit Interrupt Control Register	S0TIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	S0RIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh			
005Ch			
005Dh	INT0 Interrupt Control Register	INT0IC	XX00X000b
005Eh	UART2 Bus Collision Detection Interrupt Control Register	U2BCNIC	XXXXX000b
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh	Timer RG Interrupt Control Register	TRGIC	XXXXX000b
006Ch			
006Dh			
006Eh			
006Fh			
0070h			
0071h			
0072h	Voltage monitor 1 Interrupt Control Register	VCMP1IC	XXXXX000b
0073h	Voltage monitor 2 Interrupt Control Register	VCMP2IC	XXXXX000b
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Fh			

X: Undefined

Notes:

- Blank spaces are reserved. No access is allowed.
- Selectable by the IICSEL bit in the SSUICSR register.

Table 4.7 SFR Information (7) ⁽¹⁾

Address	Register	Symbol	After Reset
0180h	Timer RA Pin Select Register	TRASR	00h
0181h	Timer RB/RC Pin Select Register	TRBRCR	00h
0182h	Timer RC Pin Select Register 0	TRCPSR0	00h
0183h	Timer RC Pin Select Register 1	TRCPSR1	00h
0184h	Timer RD Pin Select Register 0	TRDPSR0	00h
0185h	Timer RD Pin Select Register 1	TRDPSR1	00h
0186h			
0187h	Timer RG Pin Select Register	TRGPSR	00h
0188h	UART0 Pin Select Register	U0SR	00h
0189h	UART1 Pin Select Register	U1SR	00h
018Ah	UART2 Pin Select Register 0	U2SR0	00h
018Bh	UART2 Pin Select Register 1	U2SR1	00h
018Ch	SSU/IIC Pin Select Register	SSUIICSR	00h
018Dh	Key Input Pin Select Register	KISR	00h
018Eh	INT Interrupt Input Pin Select Register	INTSR	00h
018Fh	I/O Function Pin Select Register	PINSR	00h
0190h			
0191h			
0192h			
0193h	SS Bit Counter Register	SSBR	11111000b
0194h	SS Transmit Data Register L / IIC bus Transmit Data Register ⁽²⁾	SSTDR/ICDRT	FFh
0195h	SS Transmit Data Register H ⁽²⁾	SSTDRH	FFh
0196h	SS Receive Data Register L / IIC bus Receive Data Register ⁽²⁾	SSRDR/ICDRR	FFh
0197h	SS Receive Data Register H ⁽²⁾	SSRDRH	FFh
0198h	SS Control Register H / IIC bus Control Register 1 ⁽²⁾	SSCRH/ICCR1	00h
0199h	SS Control Register L / IIC bus Control Register 2 ⁽²⁾	SSCRL/ICCR2	01111101b
019Ah	SS Mode Register / IIC bus Mode Register ⁽²⁾	SSMR/ICMR	00010000b/00011000b
019Bh	SS Enable Register / IIC bus Interrupt Enable Register ⁽²⁾	SSER/ICIER	00h
019Ch	SS Status Register / IIC bus Status Register ⁽²⁾	SSSR/ICSR	00h/0000X000b
019Dh	SS Mode Register 2 / Slave Address Register ⁽²⁾	SSMR2/SAR	00h
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h			
01A4h			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACh			
01ADh			
01AEh			
01AFh			
01B0h			
01B1h			
01B2h	Flash Memory Status Register	FST	10000X00b
01B3h			
01B4h	Flash Memory Control Register 0	FMR0	00h
01B5h	Flash Memory Control Register 1	FMR1	00h
01B6h	Flash Memory Control Register 2	FMR2	00h
01B7h			
01B8h			
01B9h			
01BAh			
01BBh			
01BCh			
01BDh			
01BEh			
01BFh			

X: Undefined

Notes:

- Blank spaces are reserved. No access is allowed.
- Selectable by the IICSEL bit in the SSUIICSR register.

Table 4.9 SFR Information (9) ⁽¹⁾

Address	Register	Symbol	After Reset
0200h	LCD Control Register	LCR0	00h
0201h	LCD Bias Control Register	LCR1	00h
0202h	LCD Display Control Register	LCR2	X0000000b
0203h	LCD Clock Control Register	LCR3	00h
0204h			
0205h			
0206h	LCD Port Select Register 0	LSE0	00h
0207h	LCD Port Select Register 1	LSE1	00h
0208h	LCD Port Select Register 2	LSE2	00h
0209h	LCD Port Select Register 3	LSE3	00h
020Ah	LCD Port Select Register 4	LSE4	00h
020Bh	LCD Port Select Register 5	LSE5	00h
020Ch	LCD Port Select Register 6	LSE6	00h
020Dh	LCD Port Select Register 7	LSE7	00h
020Eh			
020Fh			
0210h	LCD Display Data Register	LRA0L	XXh
0211h		LRA1L	XXh
0212h		LRA2L	XXh
0213h		LRA3L	XXh
0214h		LRA4L	XXh
0215h		LRA5L	XXh
0216h		LRA6L	XXh
0217h		LRA7L	XXh
0218h		LRA8L	XXh
0219h		LRA9L	XXh
021Ah		LRA10L	XXh
021Bh		LRA11L	XXh
021Ch		LRA12L	XXh
021Dh		LRA13L	XXh
021Eh		LRA14L	XXh
021Fh		LRA15L	XXh
0220h		LRA16L	XXh
0221h		LRA17L	XXh
0222h		LRA18L	XXh
0223h		LRA19L	XXh
0224h		LRA20L	XXh
0225h		LRA21L	XXh
0226h		LRA22L	XXh
0227h		LRA23L	XXh
0228h		LRA24L	XXh
0229h		LRA25L	XXh
022Ah		LRA26L	XXh
022Bh		LRA27L	XXh
022Ch		LRA28L	XXh
022Dh		LRA29L	XXh
022Eh		LRA30L	XXh
022Fh		LRA31L	XXh
0230h		LRA32L	XXh
0231h		LRA33L	XXh
0232h		LRA34L	XXh
0233h		LRA35L	XXh
0234h		LRA36L	XXh
0235h		LRA37L	XXh
0236h		LRA38L	XXh
0237h		LRA39L	XXh
0238h		LRA40L	XXh
0239h		LRA41L	XXh
023Ah		LRA42L	XXh
023Bh		LRA43L	XXh
023Ch		LRA44L	XXh
023Dh		LRA45L	XXh
023Eh		LRA46L	XXh
023Fh		LRA47L	XXh

X: Undefined

Note:

- Blank spaces are reserved. No access is allowed.

Table 4.11 SFR Information (11) ⁽¹⁾

Address	Register	Symbol	After Reset
0280h	LCD Display Control Data Register	LRA16H	XXh
0281h		LRA17H	XXh
0282h		LRA18H	XXh
0283h		LRA19H	XXh
0284h		LRA20H	XXh
0285h		LRA21H	XXh
0286h		LRA22H	XXh
0287h		LRA23H	XXh
0288h		LRA24H	XXh
0289h		LRA25H	XXh
028Ah		LRA26H	XXh
028Bh		LRA27H	XXh
028Ch		LRA28H	XXh
028Dh		LRA29H	XXh
028Eh		LRA30H	XXh
028Fh		LRA31H	XXh
0290h		LRA32H	XXh
0291h		LRA33H	XXh
0292h		LRA34H	XXh
0293h		LRA35H	XXh
0294h		LRA36H	XXh
0295h		LRA37H	XXh
0296h		LRA38H	XXh
0297h		LRA39H	XXh
0298h		LRA40H	XXh
0299h		LRA41H	XXh
029Ah		LRA42H	XXh
029Bh		LRA43H	XXh
029Ch		LRA44H	XXh
029Dh		LRA45H	XXh
029Eh		LRA46H	XXh
029Fh		LRA47H	XXh
02A0h		LRA48H	XXh
02A1h		LRA49H	XXh
02A2h		LRA50H	XXh
02A3h		LRA51H	XXh
02A4h		LRA52H	XXh
02A5h		LRA53H	XXh
02A6h		LRA54H	XXh
02A7h		LRA55H	XXh
02A8h			
02A9h			
02AAh			
02ABh			
02ACh			
02ADh			
02AEh			
02AFh			
02B0h			
02B1h			
02B2h			
02B3h			
02B4h			
02B5h			
02B6h			
02B7h			
02B8h			
02B9h			
02BAh			
02BBh			
02BCh			
02BDh			
02BEh			
02BFh			

X: Undefined

Note:

- Blank spaces are reserved. No access is allowed.

Table 4.16 SFR Information (16) ⁽¹⁾

Address	Register	Symbol	After Reset
2CF0h	DTC Control Data 22	DTCD22	XXh
2CF1h			XXh
2CF2h			XXh
2CF3h			XXh
2CF4h			XXh
2CF5h			XXh
2CF6h			XXh
2CF7h			XXh
2CF8h	DTC Control Data 23	DTCD23	XXh
2CF9h			XXh
2CFAh			XXh
2CFBh			XXh
2CFCh			XXh
2CFDh			XXh
2CFEh			XXh
2CFFh			XXh
2D00h			
:			
2FFFh			

X: Undefined

Note:

- Blank spaces are reserved. No access is allowed.

Table 4.17 ID Code Areas and Option Function Select Area

Address	Area Name	Symbol	After Reset
:			
FFDBh	Option Function Select Register 2	OFS2	(Note 1)
:			
FFDFh	ID1		(Note 2)
:			
FFE3h	ID2		(Note 2)
:			
FFEBh	ID3		(Note 2)
:			
FFEFh	ID4		(Note 2)
:			
FFF3h	ID5		(Note 2)
:			
FFF7h	ID6		(Note 2)
:			
FFFBh	ID7		(Note 2)
:			
FFFFh	Option Function Select Register	OFS	(Note 1)

Notes:

- The option function select area is allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program. Do not write additions to the option function select area. If the block including the option function select area is erased, the option function select area is set to FFh.
When blank products are shipped, the option function select area is set to FFh. It is set to the written value after written by the user.
When factory-programming products are shipped, the value of the option function select area is the value programmed by the user.
- The ID code areas are allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program. Do not write additions to the ID code areas. If the block including the ID code areas is erased, the ID code areas are set to FFh.
When blank products are shipped, the ID code areas are set to FFh. They are set to the written value after written by the user.
When factory-programming products are shipped, the value of the ID code areas is the value programmed by the user.

5.2 Recommended Operating Conditions

Table 5.2 Recommended Operating Conditions
(VCC = 1.8 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter			Conditions	Standard			Unit	
					Min.	Typ.	Max.		
Vcc/AVcc	Supply voltage				1.8	—	5.5	V	
Vss/AVss	Supply voltage				—	0	—	V	
VIH	Input “H” voltage	Other than CMOS input			4.0 V ≤ Vcc ≤ 5.5 V	0.8 Vcc	—	Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0.8 Vcc	—	Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0.9 Vcc	—	Vcc	V
		CMOS input	Input level switching function (I/O port)	Input level selection : 0.35 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.5 Vcc	—	Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0.55 Vcc	—	Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0.65 Vcc	—	Vcc	V
				Input level selection : 0.5 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.65 Vcc	—	Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0.7 Vcc	—	Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0.8 Vcc	—	Vcc	V
				Input level selection : 0.7 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0.85 Vcc	—	Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0.85 Vcc	—	Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0.85 Vcc	—	Vcc	V
VIL	Input “L” voltage	Other than CMOS input			4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.2 Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0	—	0.2 Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0	—	0.05 Vcc	V
		CMOS input	Input level switching function (I/O port)	Input level selection : 0.35 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.2 Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0	—	0.2 Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0	—	0.2 Vcc	V
				Input level selection : 0.5 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.4 Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0	—	0.3 Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0	—	0.2 Vcc	V
				Input level selection : 0.7 Vcc	4.0 V ≤ Vcc ≤ 5.5 V	0	—	0.55 Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0	—	0.45 Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0	—	0.35 Vcc	V
IOH(sum)	Peak sum output “H” current	Sum of all pins IOH(peak)				—	—	−160	mA
IOH(sum)	Average sum output “H” current	Sum of all pins IOH(avg)				—	—	−80	mA
IOH(peak)	Peak output “H” current	Port P10, P11 (2)				—	—	−40	mA
		Other pins				—	—	−10	mA
IOH(avg)	Average output “H” current (1)	Port P10, P11 (2)				—	—	−20	mA
		Other pins				—	—	−5	mA
IoL(sum)	Peak sum output “L” current	Sum of all pins IoL(peak)				—	—	160	mA
IoL(sum)	Average sum output “L” current	Sum of all pins IoL(avg)				—	—	80	mA
IoL(peak)	Peak output “L” current	Port P10, P11 (2)				—	—	40	mA
		Other pins				—	—	10	mA
IoL(avg)	Average output “L” current (1)	Port P10, P11 (2)				—	—	20	mA
		Other pins				—	—	5	mA
f(XIN)	XIN clock input oscillation frequency			2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz	
				1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz	
f(XCIN)	XCIN clock input oscillation frequency			1.8 V ≤ Vcc ≤ 5.5 V	—	32.768	50	kHz	
fOCO40M	When used as the count source for timer RC, timer RD, or timer RG (3)			2.7 V ≤ Vcc ≤ 5.5 V	32	—	40	MHz	
fOCO-F	fOCO-F frequency			2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz	
				1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz	
—	System clock frequency			2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz	
				1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz	
f(BCLK)	CPU clock frequency			2.7 V ≤ Vcc ≤ 5.5 V	—	—	20	MHz	
				1.8 V ≤ Vcc < 2.7 V	—	—	5	MHz	

Notes:

1. The average output current indicates the average value of current measured during 100 ms.
2. This applies when the drive capacity of the output transistor is set to High by registers P10DRR and P11DRR. When the drive capacity is set to Low, the value of any other pin applies.
3. fOCO40M can be used as the count source for timer RC, timer RD, or timer RG in the range of VCC = 2.7 V to 5.5V.

Table 5.4 D/A Converter Characteristics
($V_{CC}/AV_{CC} = V_{ref} = 2.7$ to 5.5 V and $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
—	Resolution		—	—	8	Bit
—	Absolute accuracy		—	—	2.5	LSB
t_{su}	Setup time		—	—	3	μs
R_o	Output resistor		—	6	—	$\text{k}\Omega$
I_{vref}	Reference power input current	(Note 1)	—	—	1.5	mA

Note:

1. This applies when one D/A converter is used and the value of the DAI register ($i = 0$ or 1) for the unused D/A converter is 00h. The resistor ladder of the A/D converter is not included.

Table 5.5 Comparator B Characteristics
($V_{CC} = 2.7$ to 5.5 V and $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V_{ref}	IVREF1, IVREF3 input reference voltage		0	—	$V_{CC} - 1.4$	V
V_i	IVCMP1, IVCMP3 input voltage		-0.3	—	$V_{CC} + 0.3$	V
—	Offset		—	5	100	mV
t_d	Comparator output delay time ⁽¹⁾	$V_i = V_{ref} \pm 100$ mV	—	0.1	—	μs
I_{CMP}	Comparator operating current	$V_{CC} = 5.0$ V	—	17.5	—	μA

Note:

1. When the digital filter is disabled.

Table 5.18 DC Characteristics (2) [4.0 V ≤ V_{CC} ≤ 5.5 V]
(T_{opr} = −20 to 85°C (N version) / −40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Condition							Standard			Unit	
			Oscillation Circuit		On-Chip Oscillator		CPU Clock	Low-Power-Consumption Setting	Other	Min.	Typ. (3)	Max.		
			XIN (2)	XCIN	High-Speed (fOCO-F)	Low-Speed								
Icc	Power supply current ⁽¹⁾	High-speed clock mode	20 MHz	Off	Off	125 kHz	No division	—			—	7.0	15	mA
			16 MHz	Off	Off	125 kHz	No division	—			—	5.6	12.5	mA
			10 MHz	Off	Off	125 kHz	No division	—			—	3.6	—	mA
			20 MHz	Off	Off	125 kHz	Divide-by-8	—			—	3.0	—	mA
			16 MHz	Off	Off	125 kHz	Divide-by-8	—			—	2.2	—	mA
			10 MHz	Off	Off	125 kHz	Divide-by-8	—			—	1.5	—	mA
		High-speed on-chip oscillator mode	Off	Off	20 MHz	125 kHz	No division	—			—	7.0	15	mA
			Off	Off	20 MHz	125 kHz	Divide-by-8	—			—	3.0	—	mA
			Off	Off	4 MHz	125 kHz	Divide-by-16	MSTIIC = 1 MSTTRD = 1 MSTTRC = 1 MSTTRG = 1			—	1	—	mA
		Low-speed on-chip oscillator mode	Off	Off	Off	125 kHz	Divide-by-8	FMR27 = 1 VCA20 = 0			—	90	400	μA
			Off	32 kHz	Off	Off	No division	FMR27 = 1 VCA20 = 0			—	100	400	μA
		Low-speed clock mode	Off	32 kHz	Off	Off	No division	FMSTP = 1 VCA20 = 0	Flash memory off Program operation on RAM		—	55	—	μA
			Wait mode	Off	Off	Off	125 kHz	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1	While a WAIT instruction is executed Peripheral clock operation		—	15	100
		Off		Off	Off	125 kHz	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off		—	4	90	μA
		Off		32 kHz	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 0	While a WAIT instruction is executed Peripheral clock off Timer RE operation in real-time clock mode	LCD drive control circuit ⁽⁴⁾ When external division resistors are used	—	7	—	μA
										LCD drive control circuit ⁽⁵⁾ When the internal voltage multiplier is used	—	12	—	μA
		Off		32 kHz	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off Timer RE operation in real-time clock mode		—	3.5	—	μA
		Stop mode	Off	Off	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	T _{opr} = 25°C Peripheral clock off		—	2.0	5.0	μA
			Off	Off	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	T _{opr} = 85°C Peripheral clock off		—	15	—	μA
		Power-off mode	Off	Off	Off	Off	—	—	T _{opr} = 25°C		—	0.02	0.2	μA
			Off	Off	Off	Off	—	—	T _{opr} = 85°C		—	0.4	—	μA

Notes:

- V_{CC} = 4.0 V to 5.5 V, single chip mode, output pins are open, and other pins are V_{SS}.
- XIN is set to square wave input.
- V_{CC} = 5.0 V
- V_{LCD} = V_{CC}, external division resistors are used for VL4 to VL1, 1/3 bias, 1/4 duty, f(FR) = 64 Hz, SEG0 to SEG55 are selected, and segment and common output pins are open. The standard value does not include the current that flows through external division resistors.
- The internal voltage multiplier is used, bits LVLS3 to LVLS0 in the LCR1 register = 1011b, 1/3 bias, 1/4 duty, f(FR) = 64 Hz, SEG0 to SEG55 are selected, and segment and common output pins are open.

Table 5.20 DC Characteristics (4) [2.7 V ≤ V_{CC} < 4.0 V]
(Topr = −20 to 85°C (N version) / −40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Condition								Standard			Unit	
			Oscillation Circuit		On-Chip Oscillator		CPU Clock	Low-Power-Consumption Setting	Other		Min.	Typ. (3)	Max.		
			XIN (2)	XCIN	High-Speed (fOCO-F)	Low-Speed									
Icc	Power supply current (1)	High-speed clock mode	20 MHz	Off	Off	125 kHz	No division	—			—	7.0	14.5	mA	
			10 MHz	Off	Off	125 kHz	No division	—			—	3.6	10	mA	
			20 MHz	Off	Off	125 kHz	Divide-by-8	—			—	3.0	—	mA	
			10 MHz	Off	Off	125 kHz	Divide-by-8	—			—	1.5	—	mA	
		High-speed on-chip oscillator mode	Off	Off	20 MHz	125 kHz	No division	—			—	7.0	14.5	mA	
			Off	Off	20 MHz	125 kHz	Divide-by-8	—			—	3.0	—	mA	
			Off	Off	10 MHz	125 kHz	No division	—			—	4.0	—	mA	
			Off	Off	10 MHz	125 kHz	Divide-by-8	—			—	1.7	—	mA	
			Off	Off	4 MHz	125 kHz	Divide-by-16	MSTIIC = 1 MSTTRD = 1 MSTTRC = 1 MSTTRG = 1			—	1	—	mA	
		Low-speed on-chip oscillator mode	Off	Off	Off	125 kHz	Divide-by-8	FMR27 = 1 VCA20 = 0			—	85	390	μA	
		Low-speed clock mode	Off	32 kHz	Off	Off	No division	FMR27 = 1 VCA20 = 0			—	90	400	μA	
			Off	32 kHz	Off	Off	No division	FMSTP = 1 VCA20 = 0	Flash memory off Program operation on RAM			—	50	—	μA
		Wait mode	Off	Off	Off	125 kHz	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1	While a WAIT instruction is executed Peripheral clock operation		—	15	90	μA	
			Off	Off	Off	125 kHz	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off		—	5	80	μA	
			Off	32 kHz	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 0	While a WAIT instruction is executed Peripheral clock off Timer RE operation in real-time clock mode	LCD drive control circuit (4) When external division resistors are used	—	5	—	μA	
									LCD drive control circuit (5) When the internal voltage multiplier is used			—	11	—	μA
			Off	32 kHz	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off Timer RE operation in real-time clock mode		—	3.5	—	μA	
		Stop mode	Off	Off	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 25°C Peripheral clock off		—	2	5.0	μA	
			Off	Off	Off	Off	—	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 85°C Peripheral clock off		—	13.0	—	μA	
		Power-off mode	Off	Off	Off	Off	—	—	Topr = 25°C		—	0.02	0.2	μA	
			Off	Off	Off	Off	—	—	Topr = 85°C		—	0.3	—	μA	

Notes:

- V_{CC} = 2.7 V to 4.0 V, single chip mode, output pins are open, and other pins are V_{SS}.
- XIN is set to square wave input.
- V_{CC} = 3.0 V
- V_{LCD} = V_{CC}, external division resistors are used for VL4 to VL1, 1/3 bias, 1/4 duty, f(FR) = 64 Hz, SEG0 to SEG55 are selected, and segment and common output pins are open. The standard value does not include the current that flows through external division resistors.
- The internal voltage multiplier is used, bits LVLS3 to LVLS0 in the LCR1 register = 1011b, 1/3 bias, 1/4 duty, f(FR) = 64 Hz, SEG0 to SEG55 are selected, and segment and common output pins are open.

5.5 AC Characteristics

Table 5.23 Timing Requirements of Synchronous Serial Communication Unit (SSU)
($V_{CC} = 1.8$ to 5.5 V, $V_{SS} = 0$ V, and $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Conditions	Standard			Unit
				Min.	Typ.	Max.	
tsucyc	SSCK clock cycle time			4	—	—	tcyc (1)
tHI	SSCK clock "H" width			0.4	—	0.6	tsucyc
tLO	SSCK clock "L" width			0.4	—	0.6	tsucyc
tRISE	SSCK clock rising time	Master		—	—	1	tcyc (1)
		Slave		—	—	1	μs
tFALL	SSCK clock falling time	Master		—	—	1	tcyc (1)
		Slave		—	—	1	μs
tsu	SSO, SSI data input setup time			100	—	—	ns
tH	SSO, SSI data input hold time			1	—	—	tcyc (1)
tLEAD	$\overline{\text{SCS}}$ setup time	Slave		1tcyc + 50	—	—	ns
tLAG	$\overline{\text{SCS}}$ hold time	Slave		1tcyc + 50	—	—	ns
tOD	SSO, SSI data output delay time			—	—	1	tcyc (1)
tsa	SSI slave access time		$2.7\text{ V} \leq V_{CC} \leq 5.5\text{ V}$	—	—	$1.5\text{tcyc} + 100$	ns
			$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$	—	—	$1.5\text{tcyc} + 200$	ns
tor	SSI slave out open time		$2.7\text{ V} \leq V_{CC} \leq 5.5\text{ V}$	—	—	$1.5\text{tcyc} + 100$	ns
			$1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$	—	—	$1.5\text{tcyc} + 200$	ns

Note:

1. $1\text{tcyc} = 1/f_1(\text{s})$

Table 5.24 Timing Requirements of I²C bus Interface ⁽¹⁾
(V_{CC} = 1.8 to 5.5 V, V_{SS} = 0 V, and T_{opr} = –20 to 85°C (N version) / –40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
t _{SCL}	SCL input cycle time		12t _{cyC} + 600 ⁽¹⁾	—	—	ns
t _{SCLH}	SCL input "H" width		3t _{cyC} + 300 ⁽¹⁾	—	—	ns
t _{SCLL}	SCL input "L" width		5t _{cyC} + 500 ⁽¹⁾	—	—	ns
t _{sf}	SCL, SDA input fall time		—	—	300	ns
t _{SP}	SCL, SDA input spike pulse rejection time		—	—	1t _{cyC} ⁽¹⁾	ns
t _{BUF}	SDA input bus-free time		5t _{cyC} ⁽¹⁾	—	—	ns
t _{STAH}	Start condition input hold time		3t _{cyC} ⁽¹⁾	—	—	ns
t _{STAS}	Retransmit start condition input setup time		3t _{cyC} ⁽¹⁾	—	—	ns
t _{STOP}	Stop condition input setup time		3t _{cyC} ⁽¹⁾	—	—	ns
t _{SDAS}	Data input setup time		1t _{cyC} + 40 ⁽¹⁾	—	—	ns
t _{SDAH}	Data input hold time		10	—	—	ns

Note:

1. 1t_{cyC} = 1/f₁(s)

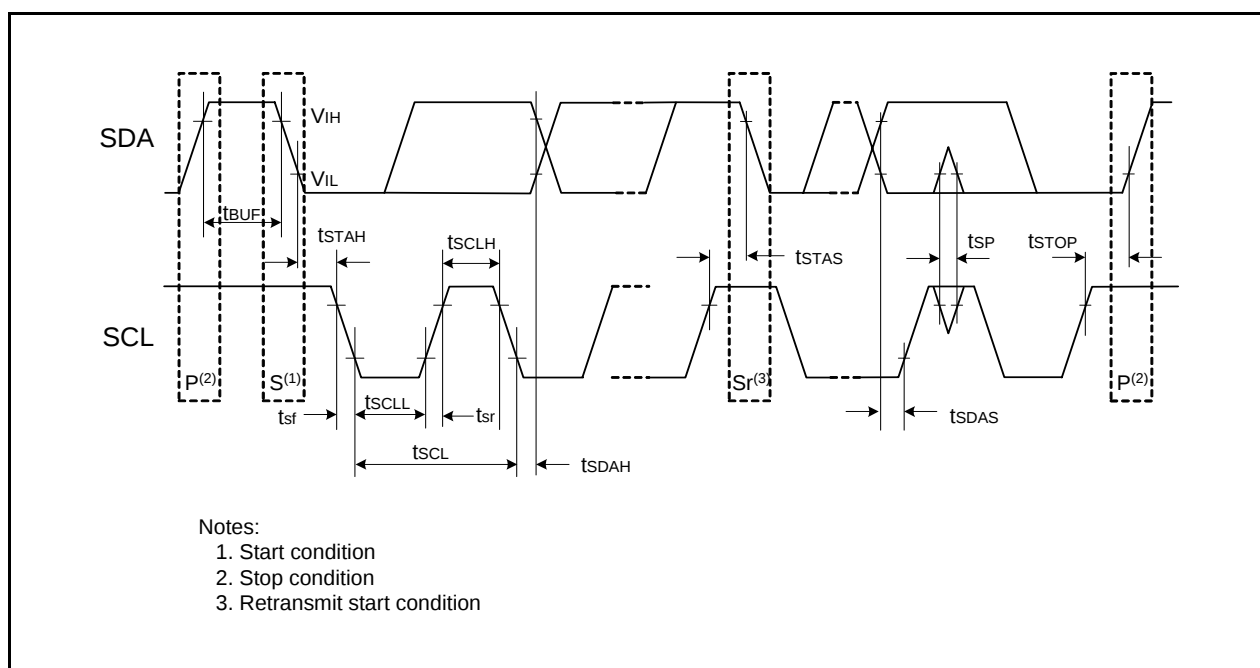


Figure 5.7 I/O Timing of I²C bus Interface

Table 5.27 Timing Requirements of Serial Interface
($V_{CC} = 1.8$ to 5.5 V, $V_{SS} = 0$ V, and $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Standard						Unit
		Vcc = 2.2V, Topr = 25°C		Vcc = 3V, Topr = 25°C		Vcc = 5V, Topr = 25°C		
		Min.	Max.	Min.	Max.	Min.	Max.	
t _c (CK)	CLKi input cycle time	800	—	300	—	200	—	ns
t _w (CKH)	CLKi input “H” width	400	—	150	—	100	—	ns
t _w (CKL)	CLKi input “L” width	400	—	150	—	100	—	ns
t _d (C-Q)	TXDi output delay time	—	200	—	80	—	50	ns
t _h (C-Q)	TXDi hold time	0	—	0	—	0	—	ns
t _{su} (D-C)	RXDi input setup time	150	—	70	—	50	—	ns
t _h (C-D)	RXDi input hold time	90	—	90	—	90	—	ns

$i = 0$ to 2

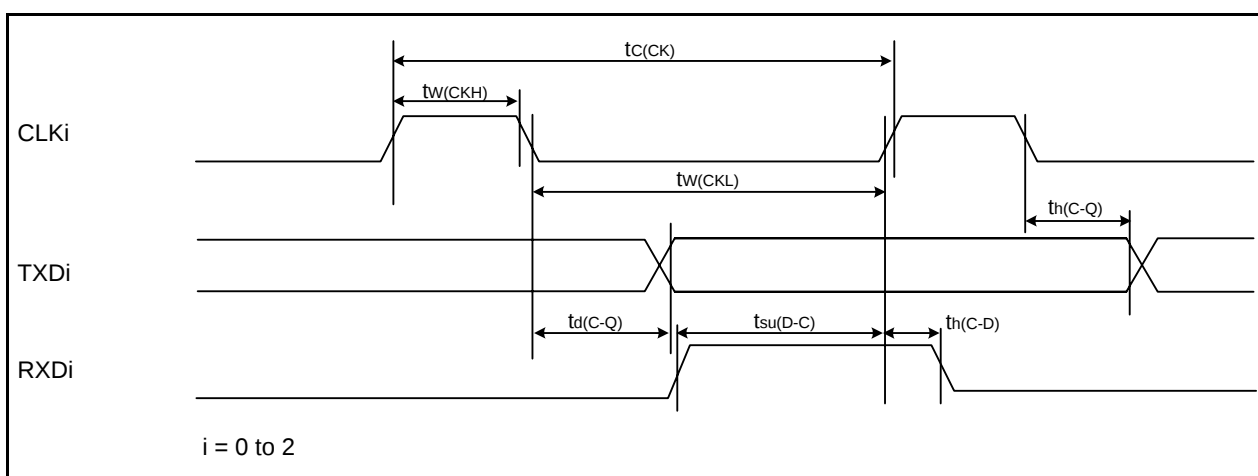


Figure 5.10 Input and Output Timing of Serial Interface

Table 5.28 Timing Requirements of External Interrupt $\overline{\text{INT}}i$ ($i = 0$ to 7) and Key Input Interrupt $\overline{\text{KLI}}i$ ($i = 0$ to 7)
($V_{CC} = 1.8$ to 5.5 V, $V_{SS} = 0$ V, and $T_{opr} = -20$ to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Standard						Unit
		Vcc = 2.2V, Topr = 25°C		Vcc = 3V, Topr = 25°C		Vcc = 5V, Topr = 25°C		
		Min.	Max.	Min.	Max.	Min.	Max.	
tw(INH)	$\overline{\text{INTi}}$ input “H” width, $\overline{\text{KLi}}$ input “H” width	1000 (1)	—	380 (1)	—	250 (1)	—	ns
tw(INL)	$\overline{\text{INTi}}$ input “L” width, $\overline{\text{KLi}}$ input “L” width	1000 (2)	—	380 (2)	—	250 (2)	—	ns

Notes:

- When selecting the digital filter by the $\overline{\text{INT}}i$ input filter select bit, use an $\overline{\text{INT}}i$ input HIGH width of either (1/digital filter clock frequency $\times 3$) or the minimum value of standard, whichever is greater.
- When selecting the digital filter by the $\overline{\text{INT}}i$ input filter select bit, use an $\overline{\text{INT}}i$ input LOW width of either (1/digital filter clock frequency $\times 3$) or the minimum value of standard, whichever is greater.

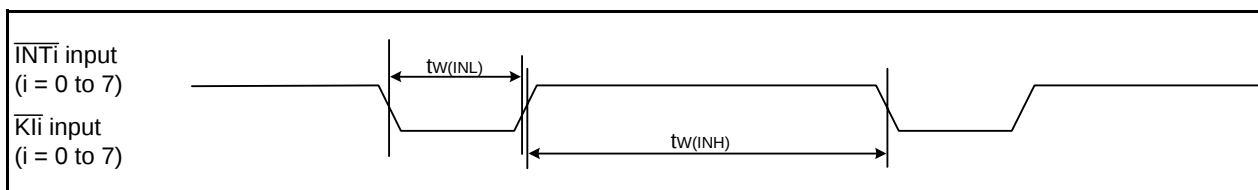
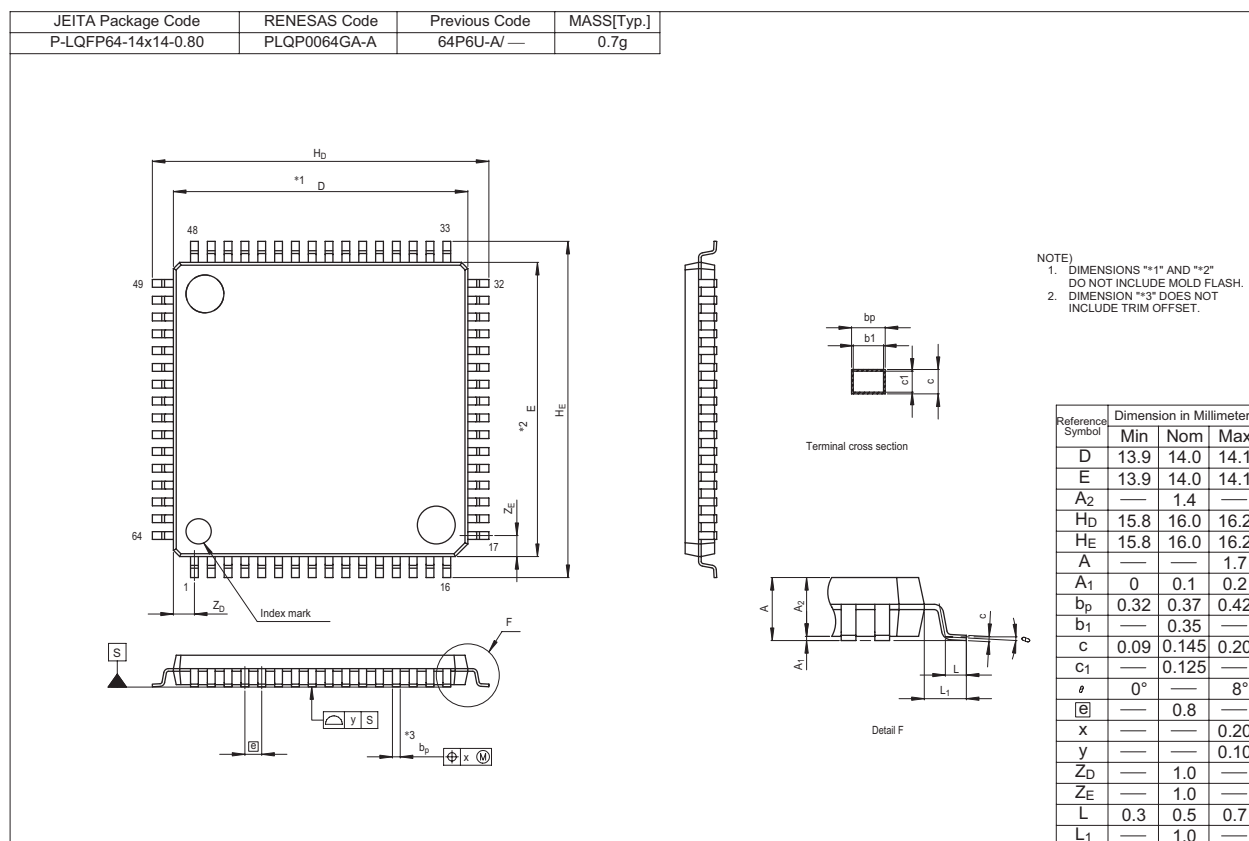
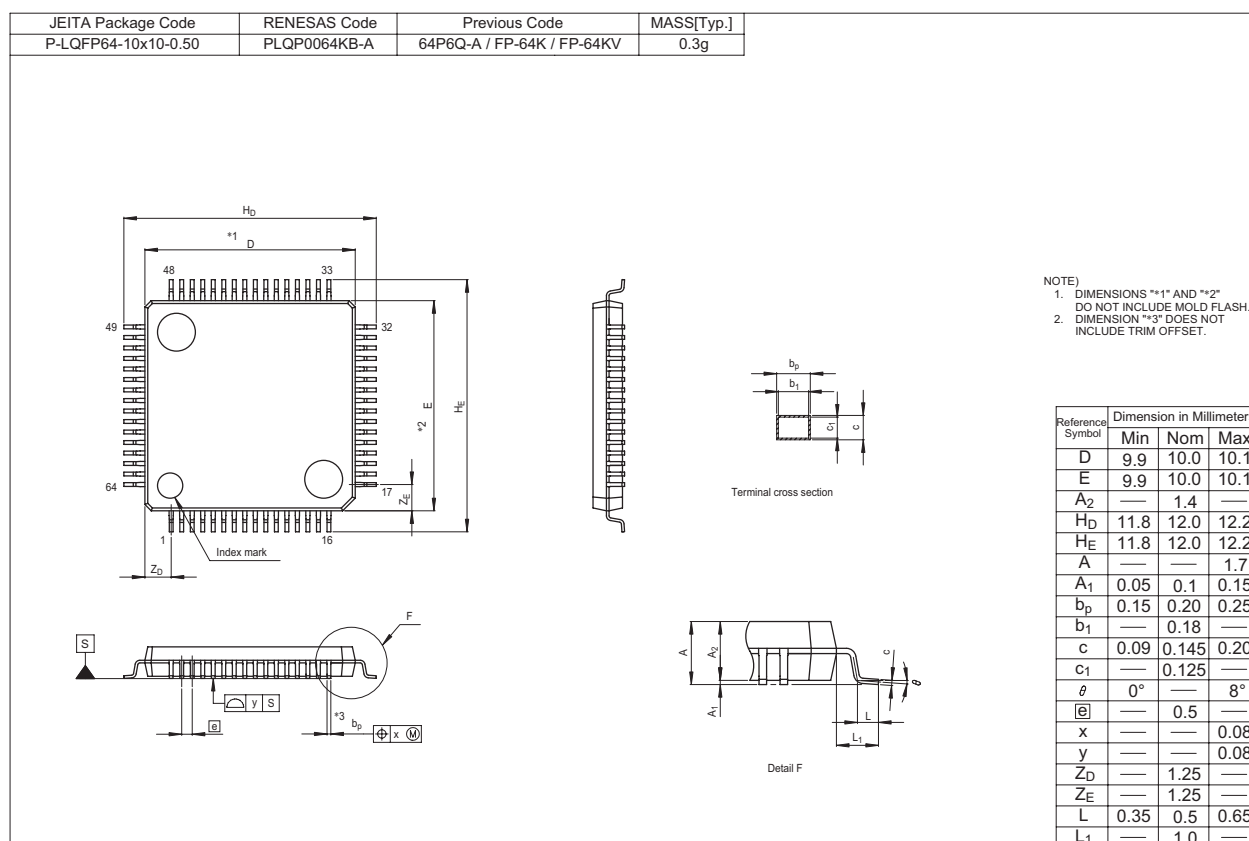
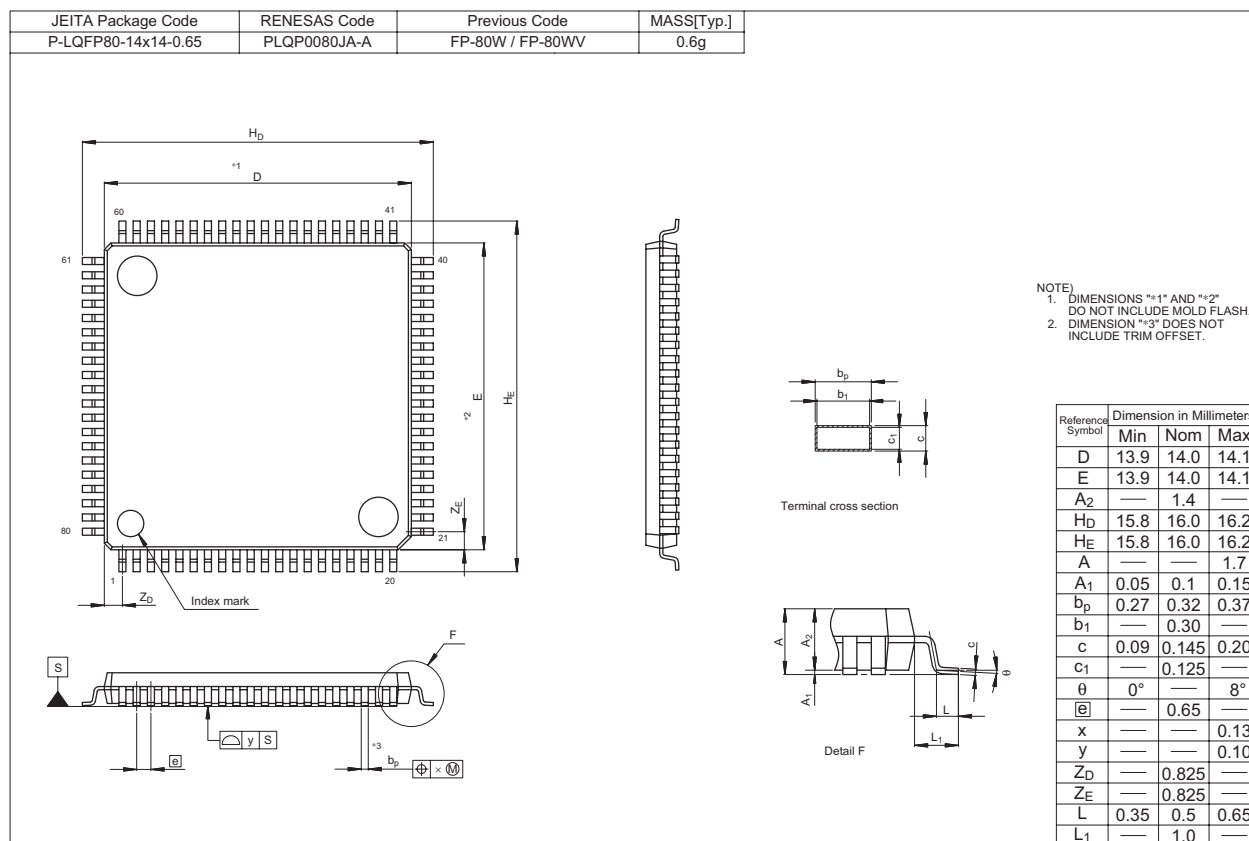
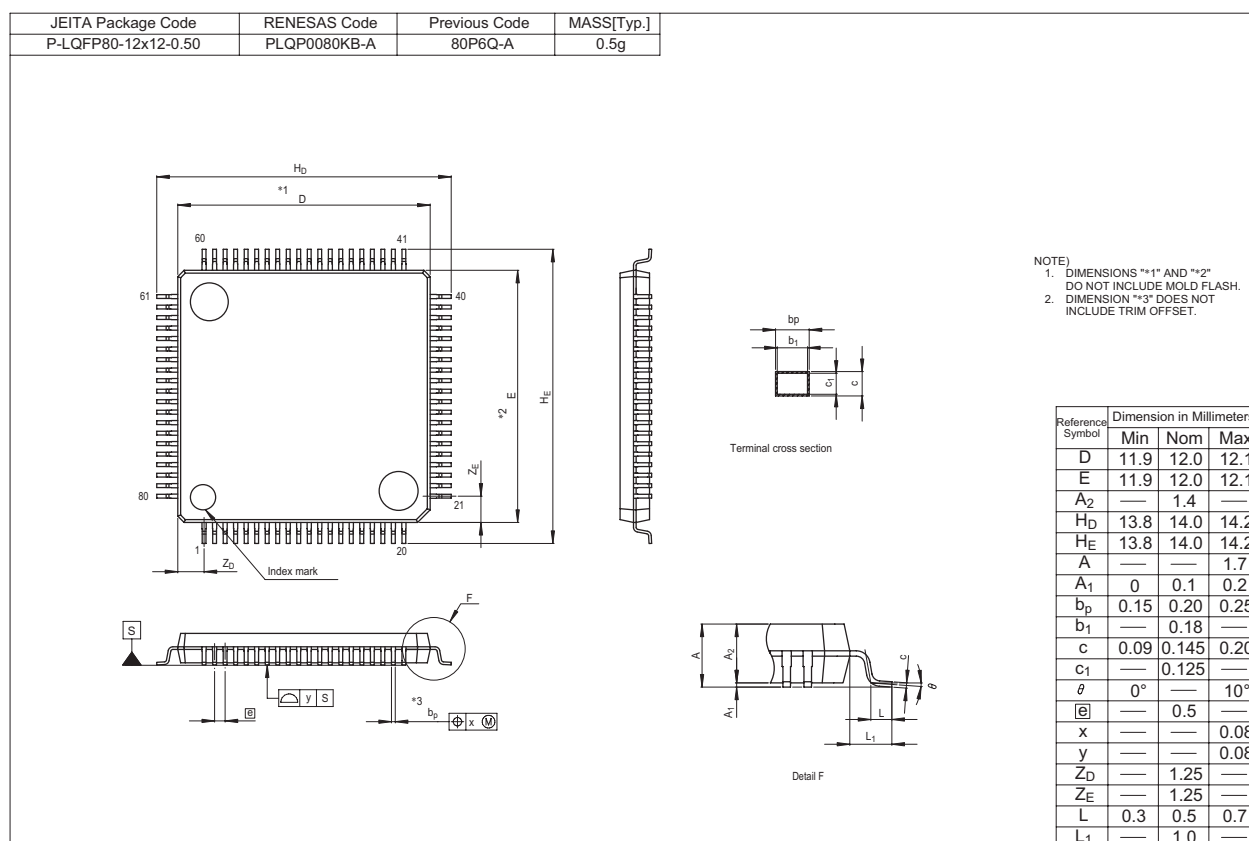


Figure 5.11 Input Timing of External Interrupt $\overline{\text{INT}}i$ and Key Input Interrupt $\overline{\text{KLI}}i$





REVISION HISTORY	R8C/L35C Group, R8C/L36C Group, R8C/L38C Group, R8C/L3AC Group Datasheet
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Rev.	Date	Description	
		Page	Summary
0.10	Oct 30, 2009	—	First Edition issued
0.20	Apr 15, 2011	6 7 7 to 10 24 29 45 to 68	Table 1.6 Function deleted, Current consumption revised 1.2 “of R8C/Lx Series” → “for Each Group” Tables 1.7 to 1.10 revised Table 1.15 “Voltage detection circuit” deleted 4. Special Function Registers (SFRs) “The description offered in this chapter is based on the R8C/L3AC Group.” added 5. Electrical Characteristics added
1.00	Jun 25, 2010	— 1 7 to 10 45 55 69 to 72	“Preliminary” and “Under development” deleted 1.1 revised Tables 1.7 to 1.10 revised Tables 5.1 Note 2 added Table 5.15 Note 3 added Package Dimensions revised
1.01	Apr 15, 2011	2 3 6 11 to 14 20 to 22 23, 24 28 38 to 40 48 57, 59, 61	Table 1.1 revised Table 1.2 Note 2, Table 1.3 Note 1 revised Table 1.6 “Flash Memory” revised Figure 1.5 to Figure 1.8 revised Table 1.11 to Table 1.13 “Voltage Detection Circuit” deleted Table 1.14 and Table 1.15 title “for R8C/L3AC Group” added 3. “The internal ROM ... with address 0FFFFh.” deleted Table 4.10 to Table 4.12 “0248h to 026Fh”, “02A8h to 02BFh”, “02C0h to 02CFh” revised Table 5.3 “tCONV”, “tSAMP” revised Table 5.18, Table 5.20, Table 5.22 “High-Speed” → “High-Speed (fOCO-F)”

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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.